Gap Pad® 3500ULM (ultra-low modulus) is an extremely soft gap filling material with a thermal conductivity of 3.5 W/m-K. The material offers exceptional thermal performance at low pressures due to a unique 3.5 W/m-K filler package and ultra-low modulus resin formulation. The enhanced material is well suited for high performance applications requiring extremely low assembly stress. Gap Pad® 3500ULM maintains a conformable nature that allows for excellent interfacing and wet-out characteristics, even to surfaces with high roughness and/or topography.

Gap Pad® 3500ULM is offered with and without fiberglass and has higher natural inherent tack on one side of the material, eliminating the need for thermally-im peding adhesive layers. The top side has minimal tack for ease of handling. Gap Pad® 3500ULM is supplied with protective liners on both sides.

**Features and Benefits**
- Thermal Conductivity: 3.5 W/m-K
- Fiberglass reinforced for shear and tear resistance
- Non-fiberglass option for applications that require an additional reduction in stress

**Typical Properties of Gap Pad 3500ULM**

<table>
<thead>
<tr>
<th>PROPERTY</th>
<th>IMPERIAL VALUE</th>
<th>METRIC VALUE</th>
<th>TEST METHOD</th>
</tr>
</thead>
<tbody>
<tr>
<td>Color</td>
<td>Gray</td>
<td>Gray</td>
<td>Visual</td>
</tr>
<tr>
<td>Reinforcement Carrier</td>
<td>Fiberglass or No fiberglass</td>
<td>Fiberglass or No fiberglass</td>
<td>—</td>
</tr>
<tr>
<td>Thickness (inch) / (mm)</td>
<td>0.020 to 0.125</td>
<td>0.508 to 3.175</td>
<td>ASTM D374</td>
</tr>
<tr>
<td>Inherent Surface Tack</td>
<td>2</td>
<td>2</td>
<td>—</td>
</tr>
<tr>
<td>Density (Bulk Rubber) (g/cc)</td>
<td>3.1</td>
<td>3.1</td>
<td>ASTM D792</td>
</tr>
<tr>
<td>Heat Capacity (J/g-K)</td>
<td>1.0</td>
<td>1.0</td>
<td>ASTM E1269</td>
</tr>
<tr>
<td>Young's Modulus (psi) / (kPa)</td>
<td>4</td>
<td>27.5</td>
<td>—</td>
</tr>
<tr>
<td>Continuous Use Temp (°F) / (°C)</td>
<td>-76 to 392</td>
<td>-60 to 200</td>
<td>—</td>
</tr>
</tbody>
</table>

**Electrical**
- Dielectric Breakdown Voltage (Vac) >5000 >5000 ASTM D149
- Dielectric Constant (1000 Hz) (3) 6.0 6.0 ASTM D150
- Volume Resistivity (Ohm-meter) 10¹⁰ 10¹⁰ ASTM D257
- Flame Rating V-O V-O UL 94

**THERMAL**
- Thermal Conductivity (W/m-K) 3.5 3.5 ASTM D5470

**Thermal Performance vs. Strain**
- Deflection (% strain) 10 20 30
- Thermal Impedance (°C-in/W) 0.040" (4)

1. Young's Modulus, calculated using 0.01 in/min. step rate of strain with a sample size of 0.79 inch² after 5 minutes of compression at 10% strain on a 1mm thickness material.
2. Thirty second delay value Shore 000 hardness scale is 70 for 125 mil.
3. Minimum value at 20 mil.
4. The ASTM D5470 test fixture was used. The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the surface roughness, flatness and pressure applied.

**Typical Applications Include:**
- Consumer electronics
- ASICs and DSPs
- Telecommunications
- PC applications

**Configurations Available:**
- Sheet form and die-cut parts
- Building a Part Number
- Standard Options
  - NA = Selected standard option. If not selecting a standard option, insert company name, drawing number, and revision level.
  - GP3500ULM = Gap Pad 3500ULM Material without fiberglass
  - GP3500ULM-G = Gap Pad 3500ULM Material with fiberglass
  - (GP3500ULM and GP3500ULM-G are also offered in a NT, non-tack, version)

**Note:** To build a part number, visit our website at www.bergquistcompany.com.